

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th style="width: 30%;">Execution Date</th> </tr> </thead> <tbody> <tr> <td>KAI LIU</td> <td>11/30/2010</td> </tr> <tr> <td>KAI-LI JIANG</td> <td>11/30/2010</td> </tr> <tr> <td>YING-HUI SUN</td> <td>11/30/2010</td> </tr> <tr> <td>SHOU-SHAN FAN</td> <td>11/30/2010</td> </tr> </tbody> </table>		Name	Execution Date	KAI LIU	11/30/2010	KAI-LI JIANG	11/30/2010	YING-HUI SUN	11/30/2010	SHOU-SHAN FAN	11/30/2010
Name	Execution Date										
KAI LIU	11/30/2010										
KAI-LI JIANG	11/30/2010										
YING-HUI SUN	11/30/2010										
SHOU-SHAN FAN	11/30/2010										
RECEIVING PARTY DATA											
<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 20%;">Name:</td> <td>Tsinghua University</td> </tr> <tr> <td>Street Address:</td> <td>No.1,Qinghua Yuan,Haidian District</td> </tr> <tr> <td>City:</td> <td>Beijing</td> </tr> <tr> <td>State/Country:</td> <td>CHINA</td> </tr> </table>		Name:	Tsinghua University	Street Address:	No.1,Qinghua Yuan,Haidian District	City:	Beijing	State/Country:	CHINA		
Name:	Tsinghua University										
Street Address:	No.1,Qinghua Yuan,Haidian District										
City:	Beijing										
State/Country:	CHINA										
<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 20%;">Name:</td> <td>HON HAI PRECISION INDUSTRY CO., LTD.</td> </tr> <tr> <td>Street Address:</td> <td>66,CHUNG SHAN ROAD</td> </tr> <tr> <td>City:</td> <td>Tu-Cheng,Taipei Hsien</td> </tr> <tr> <td>State/Country:</td> <td>TAIWAN</td> </tr> </table>		Name:	HON HAI PRECISION INDUSTRY CO., LTD.	Street Address:	66,CHUNG SHAN ROAD	City:	Tu-Cheng,Taipei Hsien	State/Country:	TAIWAN		
Name:	HON HAI PRECISION INDUSTRY CO., LTD.										
Street Address:	66,CHUNG SHAN ROAD										
City:	Tu-Cheng,Taipei Hsien										
State/Country:	TAIWAN										
PROPERTY NUMBERS Total: 1											
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 30%;">Property Type</th> <th style="width: 70%;">Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>12960658</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	12960658						
Property Type	Number										
Application Number:	12960658										
CORRESPONDENCE DATA											
<p>Fax Number: (909)978-6366</p> <p><i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 9099786584</p> <p>Email: Clifford.Chi@foxconn.com</p> <p>Correspondent Name: Clifford O. Chi</p> <p>Address Line 1: 288 South Mayo Avenue</p> <p>Address Line 4: City of Industry, CALIFORNIA 91789</p>											
ATTORNEY DOCKET NUMBER:	US33400										

501369335

PATENT
REEL: 025450 FRAME: 0745

CH \$40.00 12960658

NAME OF SUBMITTER:	Clifford O. Chi
Total Attachments: 2 source=US33400101204ASM#page1.tif source=US33400101204ASM#page2.tif	

ASSIGNMENT

In consideration of value received, the receipt and sufficiency of which are hereby acknowledged, the undersigned ASSIGNOR(S)

1. KAI LIU, residing at Beijing, China
2. KAI-LI JIANG, residing at Beijing, China
3. YING-HUI SUN, residing at Beijing, China
4. SHOU-SHAN FAN, residing at Beijing, China
5. _____, residing at _____
6. _____, residing at _____
7. _____, residing at _____
8. _____, residing at _____

hereby sell(s), assign(s) and transfer(s) unto: **TSINGHUA UNIVERSITY** having a principal place of business at **No.1, Qinghua Yuan, Haidian District, Beijing City, P.R.C.** and **HON HAI PRECISION INDUSTRY CO., LTD.** having a principal place of business at **66, Chung Shan Road, Tu-Cheng City, Taipei Hsien, Taiwan, R.O.C.** hereafter designated "ASSIGNEE" the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100, in the invention and all patent applications including any and all divisions, continuations, substitutes, and reissues thereof, and all resulting patents, known as **METHOD FOR MAKING COMPOSITE CARBON NANOTUBE STRUCTURE** for which the undersigned

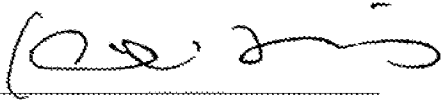
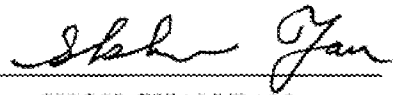
[] previously executed --- Ser. No. _____ and filing date of _____

[x] is executing concurrently herewith

an application for Letters Patent of United States of America

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorneys of record in said application, if any, shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE's full protection and title in and to the invention hereby transferred.

1.	<u>Kai Liu</u> KAI LIU	<u>Nov. 30, 2010</u> Date
2.	<u></u> KAI-LI JIANG	<u>Nov. 30, 2010</u> Date
3.	<u>Yinghui Sun</u> YING-HUI SUN	<u>Nov. 30, 2010</u> Date
4.	<u></u> SHOU-SHAN FAN	<u>Nov. 30, 2010</u> Date
5.	_____	_____ Date
6.	_____	_____ Date
7.	_____	_____ Date
8.	_____	_____ Date
9.	_____	_____ Date